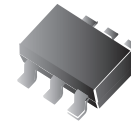


RoHS Device Halogen Free

Features

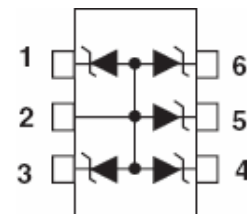
- Protects five I/O lines
- Low capacitance
- Working voltages : 5V
- Low leakage current
- Response Time is < 1 ns
- Low operating and clamping voltages
- Solid-state silicon avalanche technology
- Device Meets MSL 1 Requirements
- ROHS compliant



SOT-363

Main applications

- Cellular Handsets and Accessories
- Cordless Phones
- Personal Digital Assistants (PDA's)
- Notebooks and Handhelds
- Portable Instrumentation
- Digital Cameras
- Peripherals
- MP3 Players



Protection solution to meet

- IEC61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 8\text{kV}$ (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC 6 1000-4-5 (Lightning) 2.5A (8/20us)

Maximum ratings (Tamb=25°C Unless Otherwise Specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp=8/20µs waveform)	P _{PPP}	100	Watts
Peak Pulse Current(tp=8/20µs waveform)	I _{PP}	2.5	A
ESD Rating per IEC61000-4-2:			
Contact		8	KV
Air		15	KV
Lead Soldering Temperature	T _L	260 (10 sec.)	°C
Operating Temperature Range	T _J	-55 ~ 150	°C
Storage Temperature Range	T _{STG}	-55 ~ 150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

*Other voltages may be available upon request.

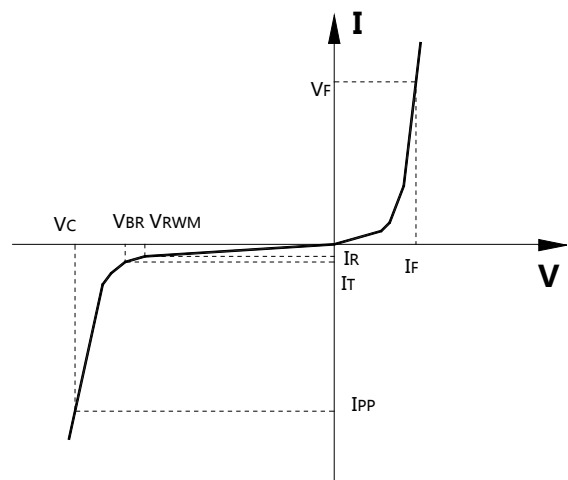
1. Nonrepetitive current pulse, per Figure 1.

Electrical characteristics (Tamb=25°C Unless Otherwise Specified)

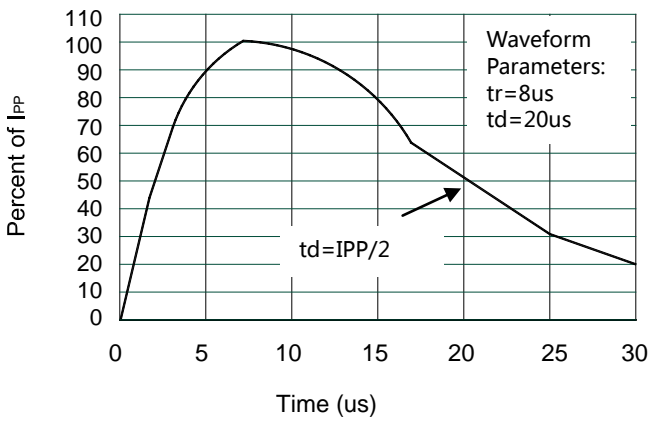
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V _{RWM}	Reverse Working Voltage				5.0	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA,	6.0			V
I _R	Reverse Leakage Current	V _{RWM} = 5V,			100	nA
V _F	Diode Forward Voltage	I _F = 15mA		0.85	1.2	V
V _C	Clamping Voltage	I _{PP} = 1A, tp =8/20µs,			10	V
		I _{PP} = 2.55A, tp =8/20µs,			13	V
I _{PP}	Peak Pulse Current	tp =8/20µs			2.5	A
C _J	Junction Capacitance	V _R = 0V, f = 1MHz,		15	20	pF

Junction capacitance is measured in VR=0V,F=1MHz

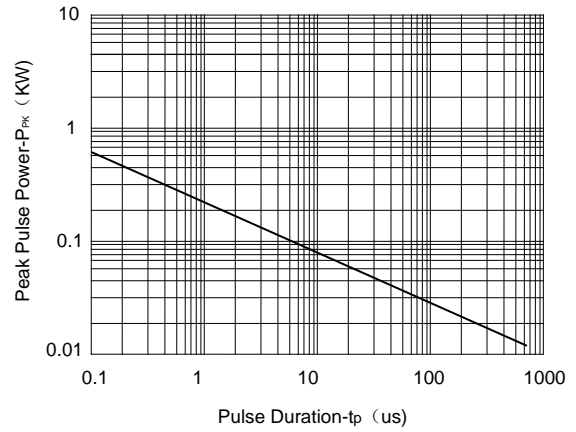
Symbol	Parameter
V _{RWM}	Working Peak Reverse Voltage
V _{BR}	Breakdown Voltage @ I _T
V _C	Clamping Voltage @ I _{PP}
I _T	Test Current
I _{RM}	Leakage current at V _{RWM}
I _{PP}	Peak pulse current
C _O	Off-state Capacitance
C _J	Junction Capacitance



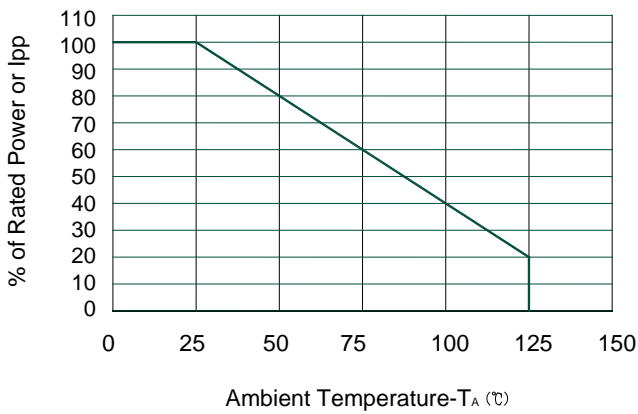
Typical electrical characterist applications



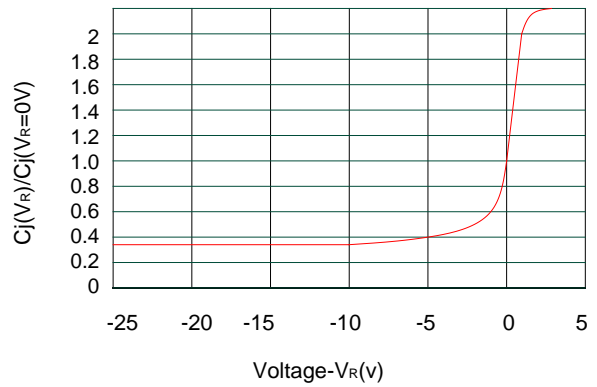
Pulse Waveform



Non-Repetitive Peak Pulse Power vs. Pulse Time

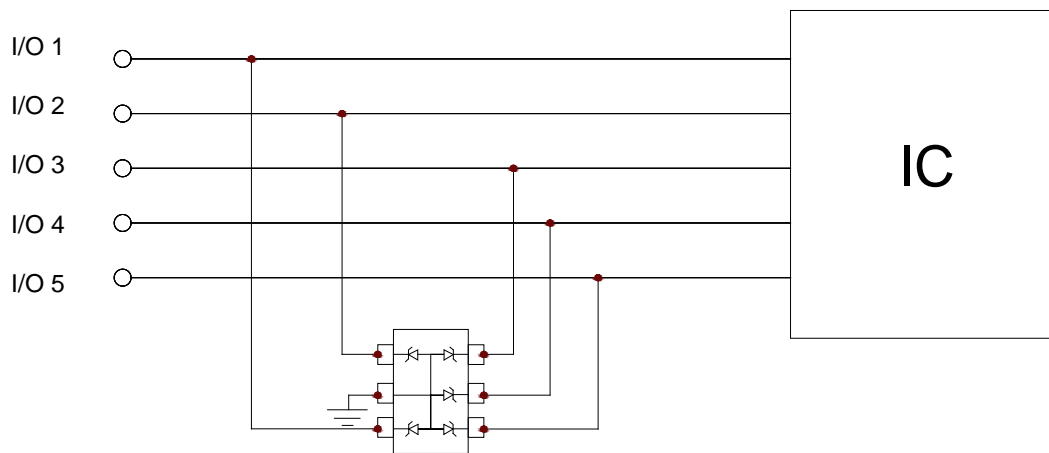


Power Derating Curve



Junction Capacitance vs. Reverse Voltage

Typical applications



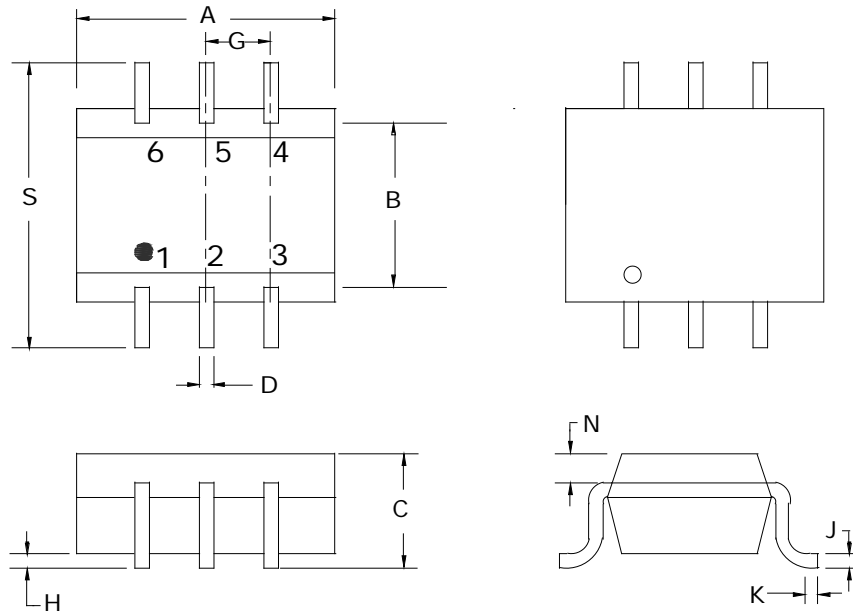
Device Connection for Protection of Five Data Lines

The PESD5V0L5UY is designed to protect up to five unidirectional data lines. The device is connected as follows:

Unidirectional protection of five I/O lines is achieved by connecting pins 1, 3, 4, 5 and 6 to the data lines. Pin 2 is connected to ground. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.

Package information

SOT-363



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.80	2.20	0.071	0.087
B	1.15	1.35	0.045	0.053
C	0.80	1.10	0.031	0.043
D	0.10	0.30	0.004	0.012
G	0.65BSC		0.026BSC	
H	--	0.10	--	0.004
J	0.10	0.25	0.004	0.010
K	0.10	0.30	0.004	0.012
N	0.20REF		0.008REF	
S	2.00	2.20	0.079	0.087